



ES3DB-ES3GB(LS)

SURFACE MOUNT SUPER FAST RECTIFIERS	REVERSE VOLTAGE – 200 to 400 Volts FORWARD CURRENT – 3.0 Ampere							
 FEATURES Glass passivated chip Super fast switching for high efficiency For surface mounted applications Low forward voltage drop and high current capability Low reverse leakage current Available in "Green" Package: SMB Lead-Free Finish; RoHS Compliant (Notes 1 & 2) Halogen and Antimony Free. "Green" Device (Note 3) MECHANICAL DATA Case: Molded plastic Case Material: Molding compound, UL Flammability classification 94V-0, "Halogen-free". Polarity: Color band denotes cathode Weight: 0.093 grams 			SMB DIM MIN A 4.06 B 3.30 C 1.96 D 0.15 E 5.21 F 0.05 G 2.01 H 0.76 All dimension in r	MAX 4.57 3.94 2.21 0.31 5.59 0.20 2.50 1.52 nillimeter				
MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS Ratings at 25°C ambient temperature unless otherwise specified.								
PARAMETER	SYMBOL	ES3DB	ES3GB	UNIT				
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	200	400	V				
Maximum RMS Voltage	V _{RMS}	140	280	V				
Maximum DC Blocking Voltage	V _{DC}	200	400	V				
Maximum Average Forward Rectified Current $@T_L=110^{\circ}C$	I _(AV)	3.	.0	А				
Peak Forward Surge Current 8.3ms single half sine-wave super imposed on rated load (JEDEC METHOD)	I _{FSM}	100 A		А				

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Maximum RMS Voltage	V _{RMS}	140	280	V
Maximum DC Blocking Voltage	V _{DC}	200	400	V
Maximum Average Forward Rectified Current @TL=1	10°C I _(AV)	3.0		A
Peak Forward Surge Current 8.3ms single half sine-wave super imposed on rated load (JEDEC METHOD)	I _{FSM}	1	00	А
Maximum forward Voltage at 3.0A DC	VF	0.92	1.25	V
Maximum DC Reverse Current@ T_=2at Rated DC Blocking Voltage@ T_=1		10 500		uA
Maximum Reverse Recovery Time (Note 4)	t _{rr}	2	5	ns
Typical Reverse Recovery Time	t _{rr}	2	0	ns
Typical Junction Capacitance (Note 5)	Ст	4	5	pF
Typical Thermal Resistance (Note 6)	R _{thJA} R _{thJL} R _{thJC}	50 15 15		°C/W
Operating Temperature Range	TJ	-55 to + 150		°C
Storage Temperature Range	T _{STG}	-55 t	o + 150	°C
Note :			REV-11, Oc	ct-2021, KSGB02

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

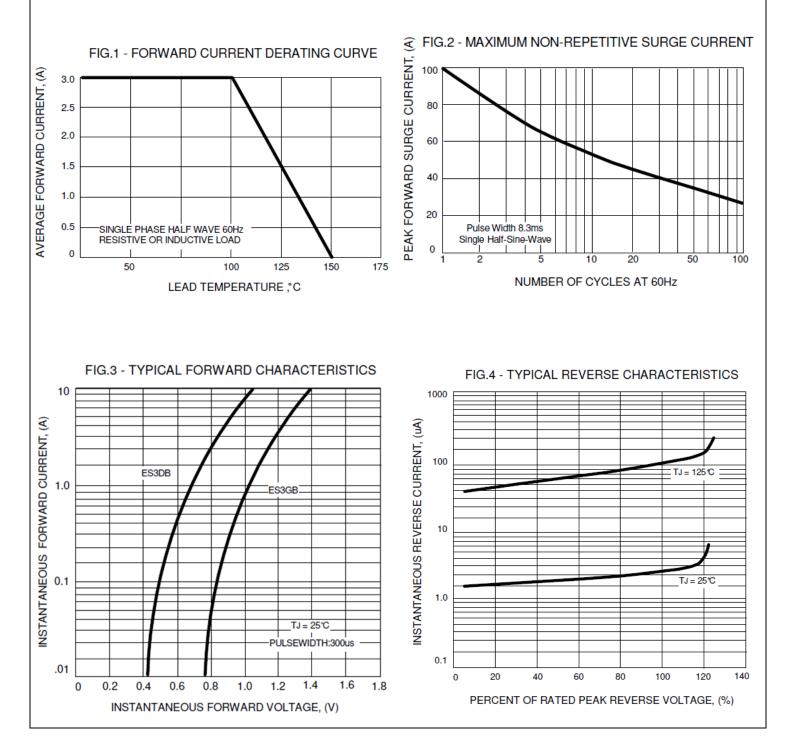
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Reverse Recovery Test Conditions :I_F=0.5A,I_R=1.0A,I_{rr}=0.25A.

5. Measured at 1.0MHz and applied reverse voltage of 4.0V DC. 6. Thermal Resistance junction to Ambient, Lead and Case.



LITE-ON SEMICONDUCTOR

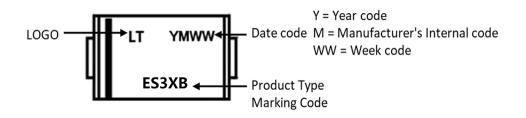




Ordering Information:

Part Number	Dackaga	Packing		
	Package	Qty.	Carrier	
ES3DB_HF	SMB	3000	Reel	
ES3GB_HF	SMB	3000	Reel	

Marking Information:





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